

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number:	SI2366DS-T1-BE3
Manufacturer:	Vishay Siliconix
Package:	Please confirm with sales
Availability:	Please confirm with sales

Product Page:

<https://antrexco.com/product/details/vishay-siliconix/si2366ds-t1-be3.html>

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New & Original Components

Supplier verification and packaging condition review

CoC / RoHS / REACH documents available on request

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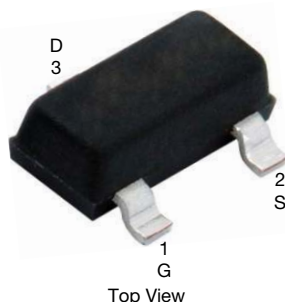
Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.

N-Channel 30 V (D-S) MOSFET

SOT-23 (TO-236)



Marking code: H6

PRODUCT SUMMARY	
V_{DS} (V)	30
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 10$ V	0.036
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5$ V	0.042
Q_g typ. (nC)	3.2
I_D (A) ^a	5.8
Configuration	Single

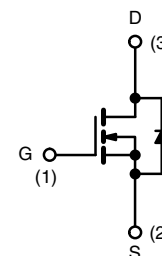
FEATURES

- TrenchFET® power MOSFET
- 100 % R_g tested
- Material categorization:
for definitions of compliance please
see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- DC/DC converters, high frequency switching
- Load switch
- Portable and consumer applications



N-Channel MOSFET

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	Si2366DS-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	30	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current ($T_J = 150$ °C)	$T_C = 25$ °C	I_D	5.8 ^a	A
	$T_C = 70$ °C		4.7	
	$T_A = 25$ °C		4.5 ^{b, c}	
	$T_A = 70$ °C		3.6 ^{b, c}	
Pulsed drain current ($t = 300$ μ s)		I_{DM}	20	A
Continuous source-drain diode current	$T_C = 25$ °C	I_S	1.75	
	$T_A = 25$ °C		1.04 ^{b, c}	
Maximum power dissipation	$T_C = 25$ °C	P_D	2.1	W
	$T_C = 70$ °C		1.3	
	$T_A = 25$ °C		1.25 ^{b, c}	
	$T_A = 70$ °C		0.8 ^{b, c}	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C
Soldering recommendations (peak temperature)			260	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^{b, d}	$t \leq 5$ s	R_{thJA}	80	100	°C/W
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	40	60	

Notes

- Based on $T_C = 25$ °C
- Surface mounted on 1" x 1" FR4 board
- $t = 5$ s
- Maximum under steady state conditions is 125 °C/W

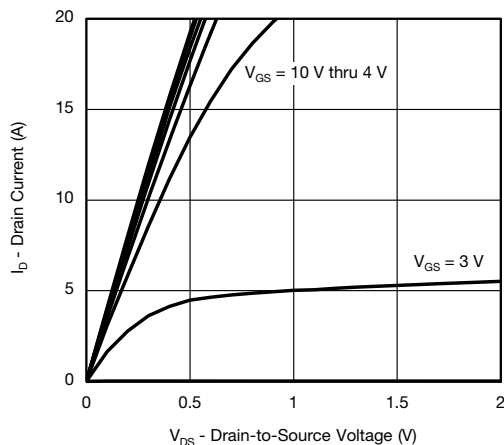
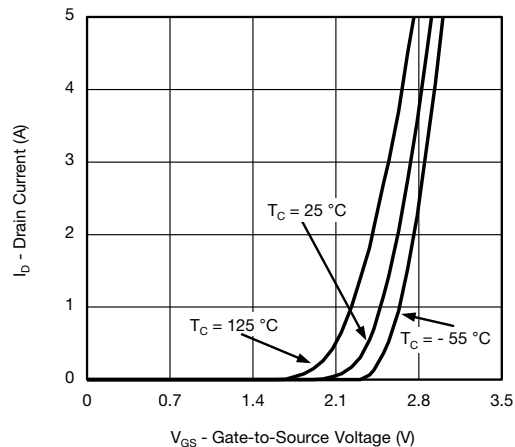
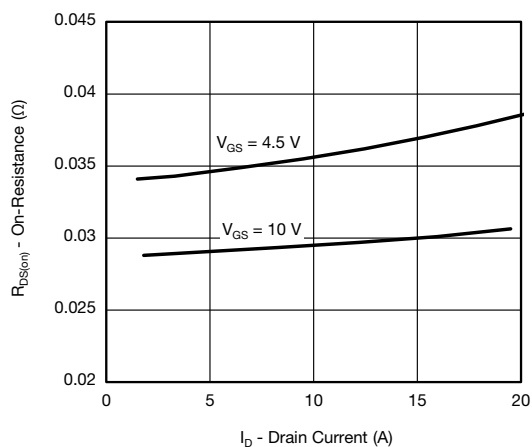
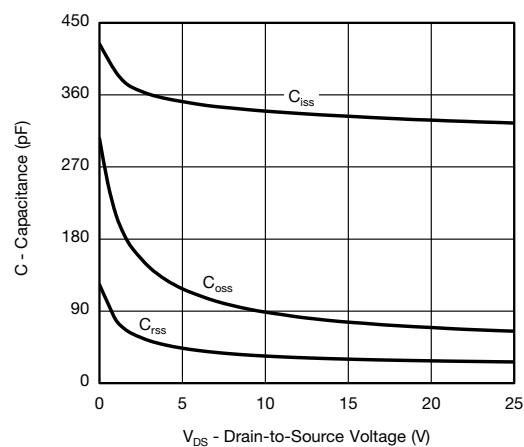
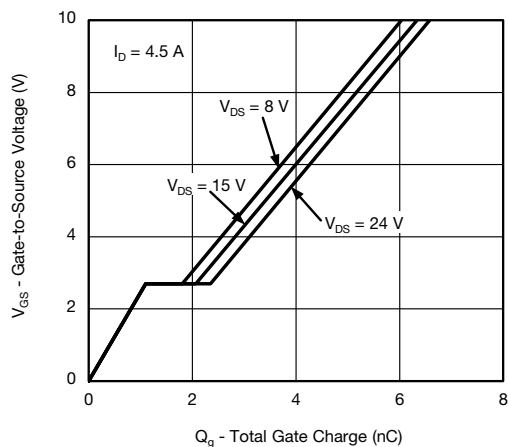
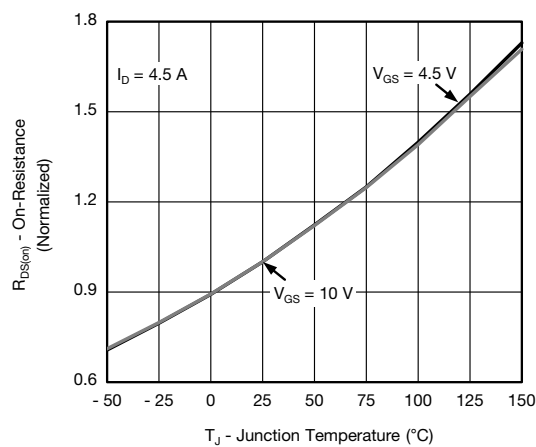


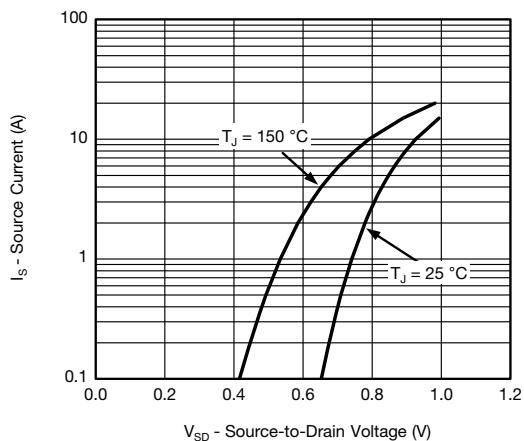
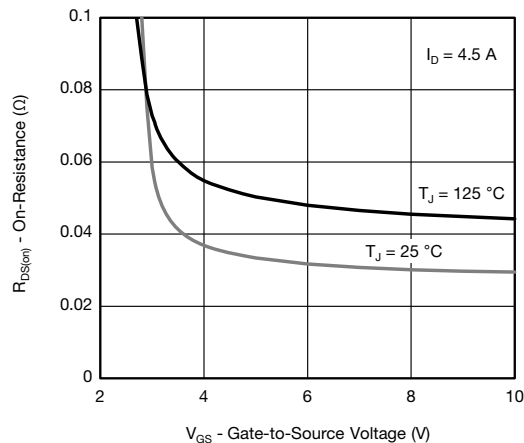
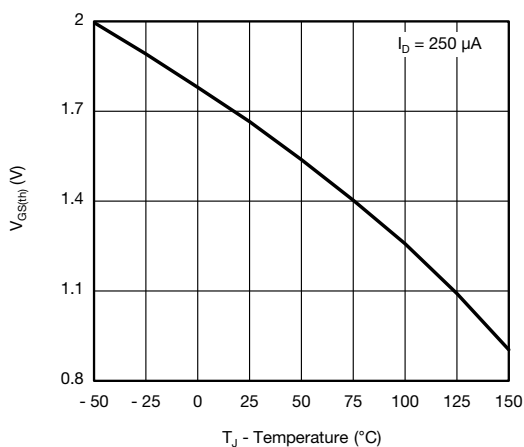
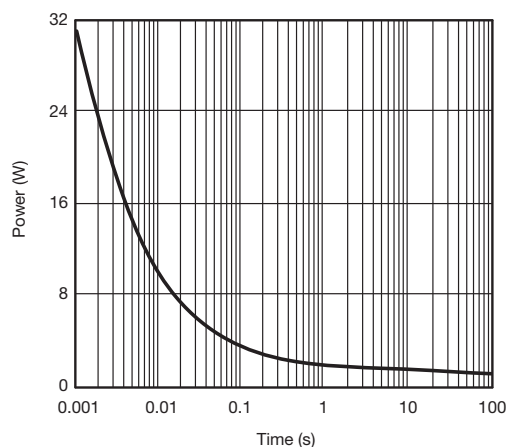
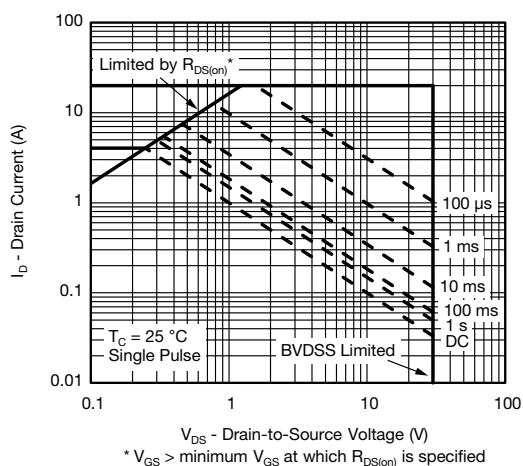
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30	-	-	V
V _{DS} temperature coefficient	ΔV _{DS} /T _J	I _D = 250 μA	-	33	-	mV/°C
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J		-	-5.5	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.2	-	2.5	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	-	-	1	μA
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 70 °C	-	-	10	
On-state drain current ^a	I _{D(on)}	V _{DS} ≤ 5 V, V _{GS} = 10 V	20	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 4.5 A	-	0.030	0.036	Ω
		V _{GS} = 4.5 V, I _D = 4.2 A	-	0.035	0.042	
Forward transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 4.5 A	-	13	-	S
Dynamic ^b						
Input capacitance	C _{iss}	V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz	-	335	-	pF
Output capacitance	C _{oss}		-	78	-	
Reverse transfer capacitance	C _{rss}		-	30	-	
Total gate charge	Q _g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 4.5 A	-	6.4	10	nC
		V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 4.5 A	-	3.2	5	
Gate-source charge	Q _{gs}		-	1.1	-	
Gate-drain charge	Q _{gd}		-	1.3	-	
Gate resistance	R _g	f = 1 MHz	0.7	3.5	7	Ω
Turn-on delay time	t _{d(on)}	V _{DD} = 15 V, R _L = 4.2 Ω I _D ≅ 3.5 A, V _{GEN} = 4.5 V, R _g = 1 Ω	-	32	48	ns
Rise time	t _r		-	48	71	
Turn-off delay time	t _{d(off)}		-	18	27	
Fall time	t _f		-	20	30	
Turn-on delay time	t _{d(on)}	V _{DD} = 15 V, R _L = 4.2 Ω I _D ≅ 3.6 A, V _{GEN} = 10 V, R _g = 1 Ω	-	5	10	
Rise time	t _r		-	12	20	
Turn-off delay time	t _{d(off)}		-	14	21	
Fall time	t _f		-	8	16	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	1.75	A
Pulse diode forward current	I _{SM}		-	-	20	
Body diode voltage	V _{SD}	I _S = 3.6 A, V _{GS} = 0 V	-	0.85	1.2	V
Body diode reverse recovery time	t _{rr}	I _F = 3.6 A, di/dt = 100 A/μs, T _J = 25 °C	-	12	18	ns
Body diode reverse recovery charge	Q _{rr}		-	5	10	nC
Reverse recovery fall time	t _a		-	7	-	ns
Reverse recovery rise time	t _b		-	5	-	

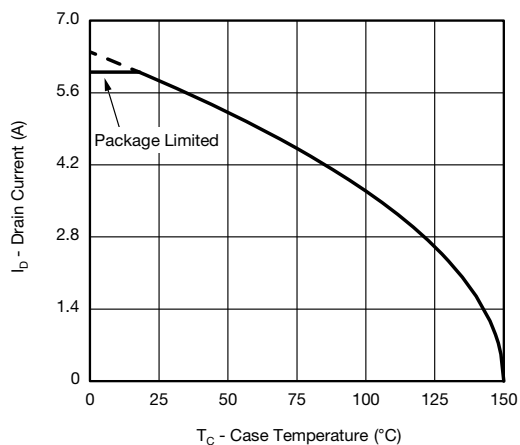
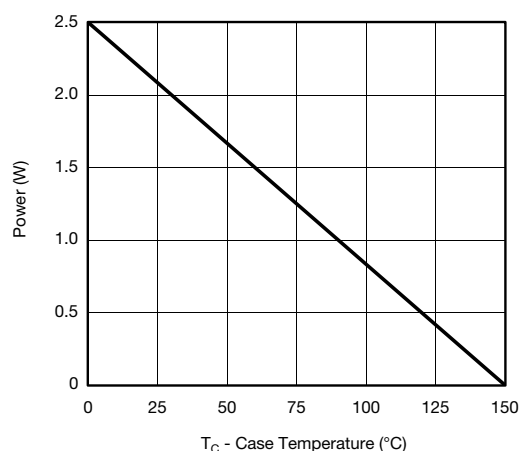
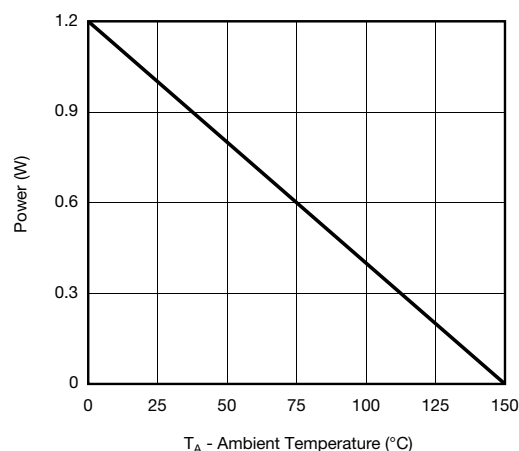
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current and Gate Voltage

Capacitance

Gate Charge

On-Resistance vs. Junction Temperature

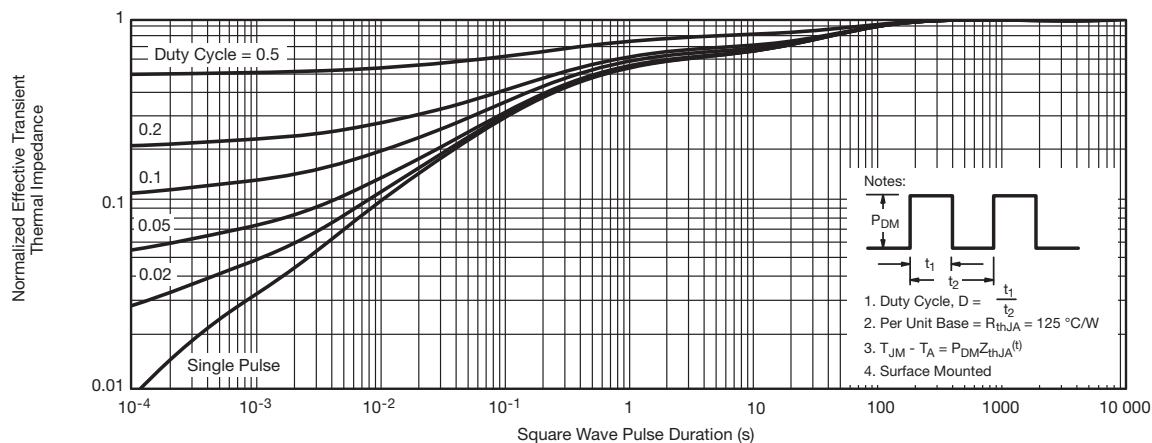
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Source-Drain Diode Forward Voltage

On-Resistance vs. Gate-to-Source Voltage

Threshold Voltage

Single Pulse Power (Junction-to-Ambient)

Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Current Derating ^a

Power Derating, Junction-to-Foot

Power Derating, Junction-to-Ambient
Note

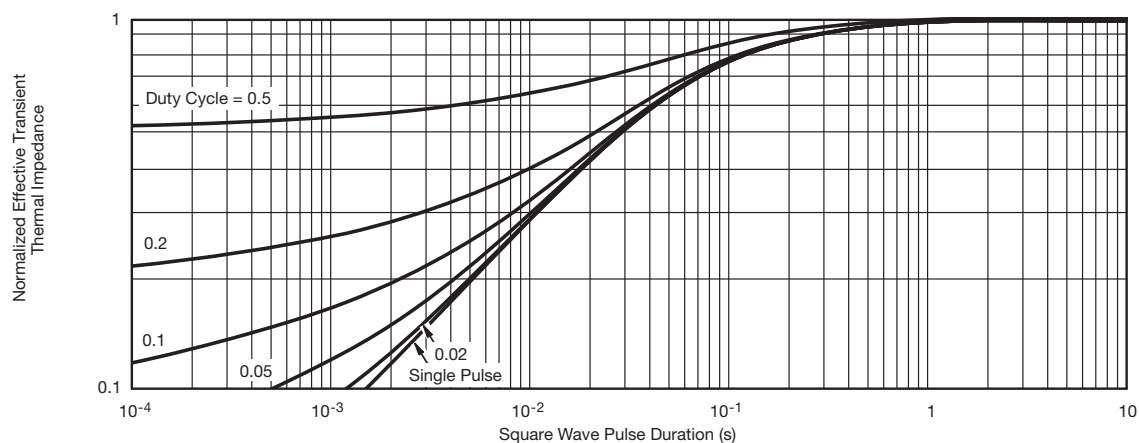
- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

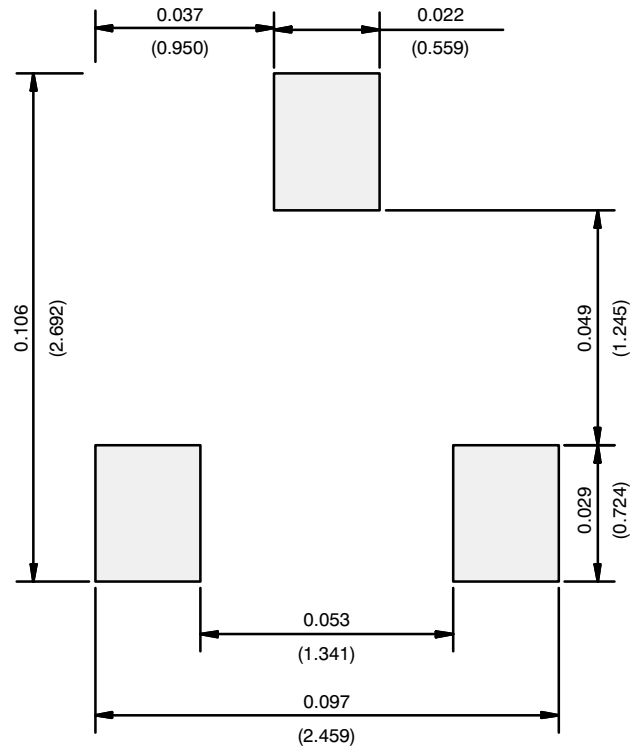
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SOT-23 (TO-236): 3-LEAD



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	0.89	1.12	0.035	0.044
A ₁	0.01	0.10	0.0004	0.004
A ₂	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
c	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E ₁	1.20	1.40	0.047	0.055
e	0.95 BSC		0.0374 Ref	
e ₁	1.90 BSC		0.0748 Ref	
L	0.40	0.60	0.016	0.024
L ₁	0.64 Ref		0.025 Ref	
S	0.50 Ref		0.020 Ref	
q	3°	8°	3°	8°
ECN: S-03946-Rev. K, 09-Jul-01				
DWG: 5479				

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads
Dimensions in Inches/(mm)

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